



# Product Change Notification

**Change Notification #:** 117245 - 00  
**Change Title:** Intel® Server System R1304SPOSHBNR,  
PCN 117245-00, Product Design, Update  
350W Power Supply Due to EOL of  
Components  
**Date of Publication:** November 01, 2019

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	November 16, 2019
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## Description of Change to the Customer:

Intel is implementing the following changes on the Intel® Server System R1304SPOSHBNR:

Due to a diode and a crystal oscillator component going End of Life (EOL) by one of our vendors, these original parts will be replaced by a second source in the 350W Power Supply.

Both new components are identical in function or form factor to the previous ones, and no functionality is affected by the change.

## Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications.

Please contact your Intel representative for further questions or concerns

## Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
R1304SPOSHBNR	951872	J49134-009	J49134-010

## PCN Revision History:

<b>Date of Revision:</b>	<b>Revision Number:</b>	<b>Reason:</b>
November 1, 2019	00	Originally Published PCN



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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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